

September 13, 2002

## **eTeraView**

The e-newsletter of Teradyne's Assembly Test Division

Because Technology Never Stops.

### **NEWS AND ANNOUNCEMENTS**

#### **Teradyne Delivers High-Speed Optical Inspection and Local Support to Beijing International Switching Systems Corporation (BISC)**

BISC will take delivery of two Teradyne Optima 7300 post-reflow automated optical inspection (AOI) systems, the first of their kind to be used in China. To read more about the BISC evaluation and their selection of the Optima 7300 system, click here:

[http://www.teradyne.com/prods/cbt/news/newsdesk/64news\\_pr\\_020903.html](http://www.teradyne.com/prods/cbt/news/newsdesk/64news_pr_020903.html)

#### **Teradyne Features Latest Technologies at Globaltronics; Advanced Systems Meet Needs of Asia Pacific Manufacturers**

Teradyne showcased its leading electronics test solutions at Globaltronics in early September. To read details about the featured solutions, click here:

[http://www.teradyne.com/prods/cbt/news/newsdesk/63news\\_pr\\_020903.html](http://www.teradyne.com/prods/cbt/news/newsdesk/63news_pr_020903.html)

### **PRODUCT INFORMATION**

#### **New Release of VICTORY™ Boundary Scan Software scheduled for October 1, 2002**

The new VICTORY software, Version 2.5, is ready for release and will begin shipping on October 1. Several key enhancements are included in this new release of software. For specific information about the enhancements, click here:

<http://www.teradyne.com/prods/cbt/cbthome.html>

All customers who are up-to-date on their software support agreements are eligible for this latest release and will receive it free of charge. It will also be available (after October 1) as a download from the Customer Zone Support web site at:

[http://www.teradyne.com/prods/cbt/support/sup\\_home.html](http://www.teradyne.com/prods/cbt/support/sup_home.html)

You must have an account to access this file in the Customer Zone web site.

Click the following link to request an account.

[http://www.teradyne.com/prods/cbt/support/sup\\_f\\_logreq.html](http://www.teradyne.com/prods/cbt/support/sup_f_logreq.html)

### **RECENT TECHNICAL PAPERS, ARTICLES, & PUBLICATIONS**

#### **"Flying Probe: An Integral Test Method" by Gary J. Boutin**

A new generation of flying probe test systems can be integrated with in-circuit, x-ray and functional tests to optimize fault coverage. To read more about the benefits of flying probes as part of an overall test strategy, click here:

[http://www.teradyne.com/prods/cbt/products/library/pilot/flyprob\\_circass0208.pdf](http://www.teradyne.com/prods/cbt/products/library/pilot/flyprob_circass0208.pdf)

## UPCOMING EVENTS

### **Optimizing Imaging Strategies in Today's Manufacturing Environment – September 17 & 18, 2002**

Join us in Toronto, Canada, on Tuesday, September 17, or in Montreal, Canada, on Wednesday, September 18, to see the latest in automated optical and x-ray inspection as well as Teradyne's new Design-to-Build Software Technology. Find out what technology is optimal for your manufactured product mix. Click here for complete details about the seminars and for information on how to register:

<http://www.teradyne.com/prods/cbt/news/tradeshows/02d2bimg-sem.html>

### **ARC Forum 2002, Boston, MA – September 17-18, 2002**

The focus of the program is Driving Operational Excellence - Collaborative Manufacturing and Supply Chain Strategies. Teradyne will exhibit its SCE Manufacturing Software. For more information, click here:

<http://www.teradyne.com/prods/cbt/news/tradeshows/02arc.html>

### **Manufacturing Execution Software (MES) Webinar, September 24, 2002**

Join us on September 24 for a free webcast to learn about optimizing your manufacturing operations with Teradyne SCE. Click here for more information or to register for this program:

[http://www.teradyne.com/prods/sce/newsevents/newsevents\\_events.html](http://www.teradyne.com/prods/sce/newsevents/newsevents_events.html)

### **Teradyne Users' Group (TUG) – May 2003**

The TUG Steering Committee is currently at work preparing the logistics and the technical program for TUG 2003. It is not too early to begin thinking about presenting a paper in Nashville. A list of "Hot Topics" for each product group will appear on the TUG website in the next few weeks. The official Call for Papers began in early September and all abstracts must be submitted by mid-November. Click here for actual dates and submission details:

<http://www.teradyne.com/prods/tug/tughome.html>

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[http://www.teradyne.com/prods/cbt/news/news\\_pubs.html](http://www.teradyne.com/prods/cbt/news/news_pubs.html)

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